

Plasma and Surface Technologies for Energy Applications & Sustainability



Stefan Saager

Manufacturing World 2024, Tokyo



Fraunhofer Society – Bridging basic research and industrial development

Applied Research in Germany



world's leading applied research organization, founded in 1949



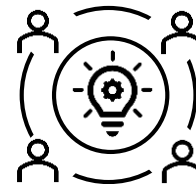
76 institutes and research institutions



approx. 32 000 employees



headquarter in Munich



each institute has its own core competences and act as individual profit center on the market



Fraunhofer Institute for Electron Beam and Plasma Technology FEP

The Institute in Figures

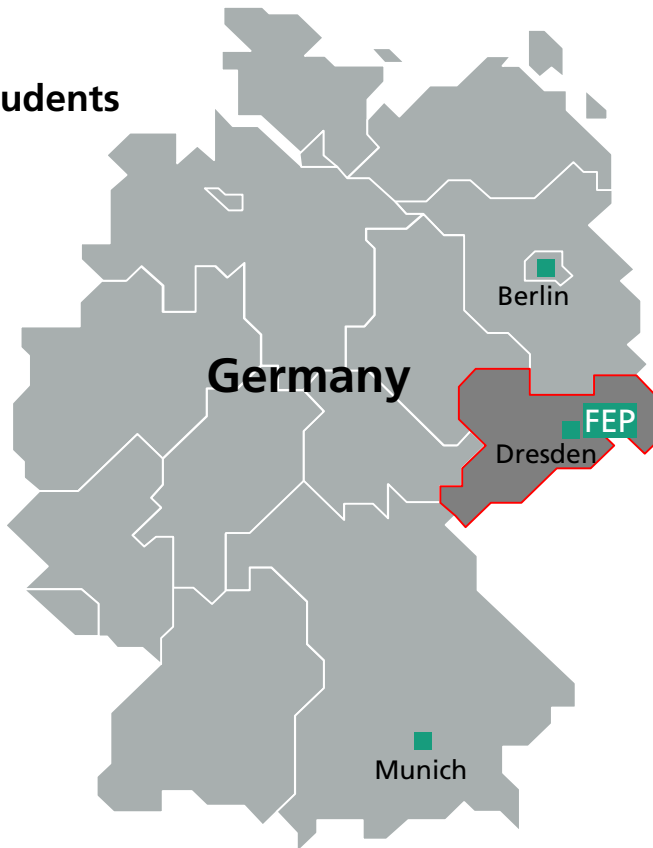
Employees	196 incl. students
Total budget	30.7 M€
Industry returns	11.6 M€
Public funding	6.2 M€
Investments	2.1 M€

(April 2024 | Figures from 2023)

Director



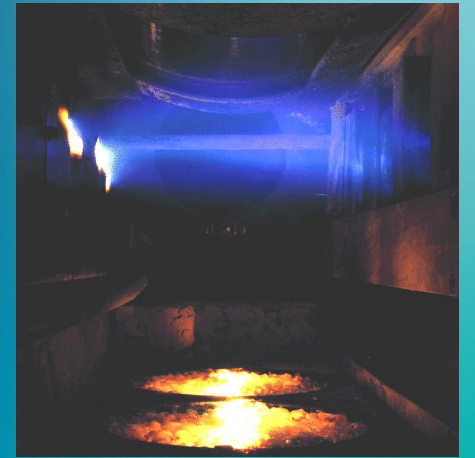
Prof. Dr. Elizabeth von Hauff



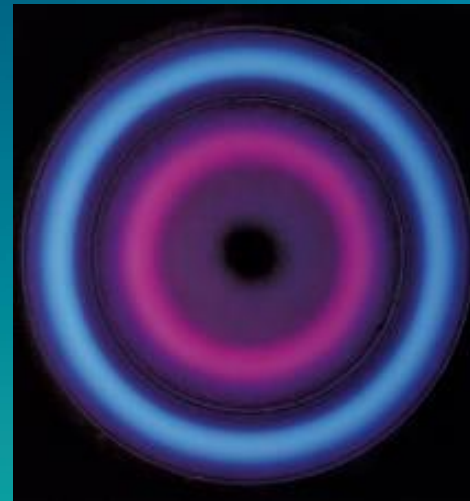
Core competences



Electron Beam Technologies



Plasma Surface Technologies



Sputter Technologies



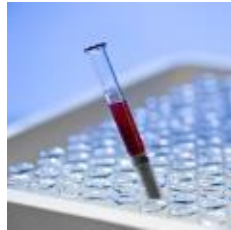
Technological Key Components



Industry Solutions



**Energy and
Sustainability**



Life Sciences



**Environmental
Technologies**



Smart Building



Mobility



**Optic, Sensorics
and Electronics**



Smart Farming



Packaging



**Mechanical
Engineering**

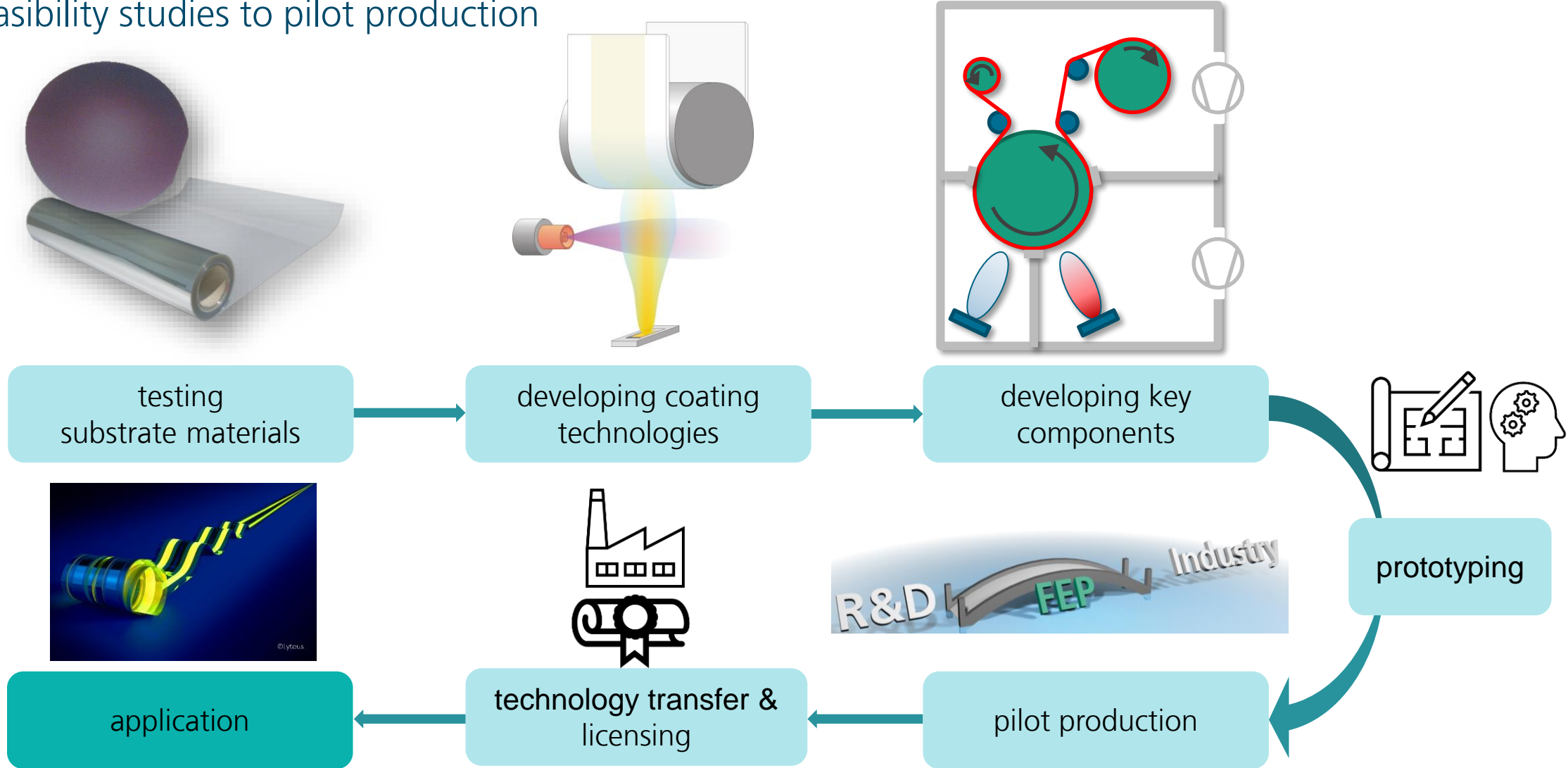


**Cultural Heritage
and Preservation**



Fraunhofer FEP support for product development

From feasibility studies to pilot production

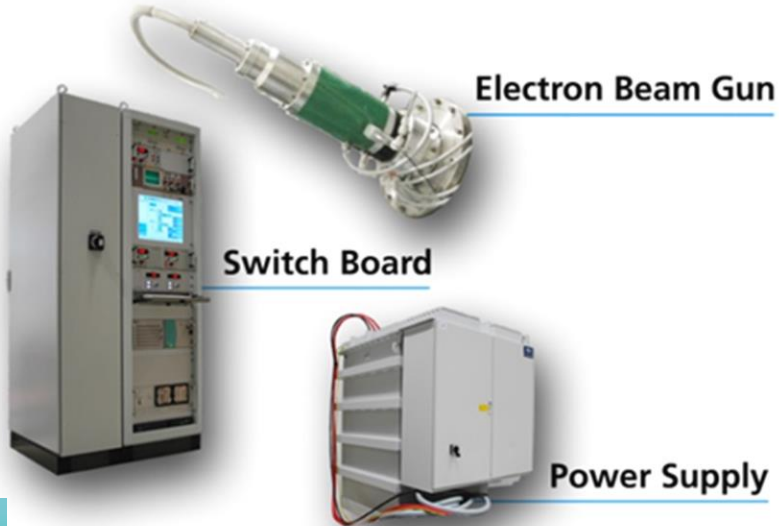


Key components

Integrated Packages

Mechanical
Components

Integrated package



Integrated package



Technology

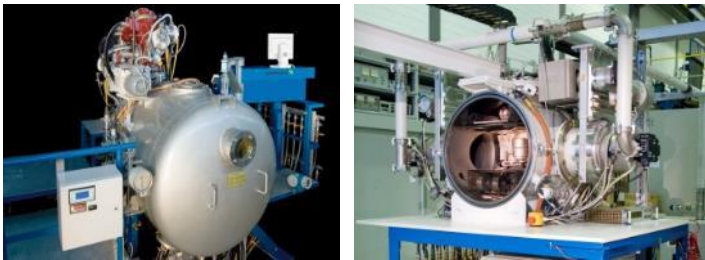
Electronical
Components

Control /
Visualization

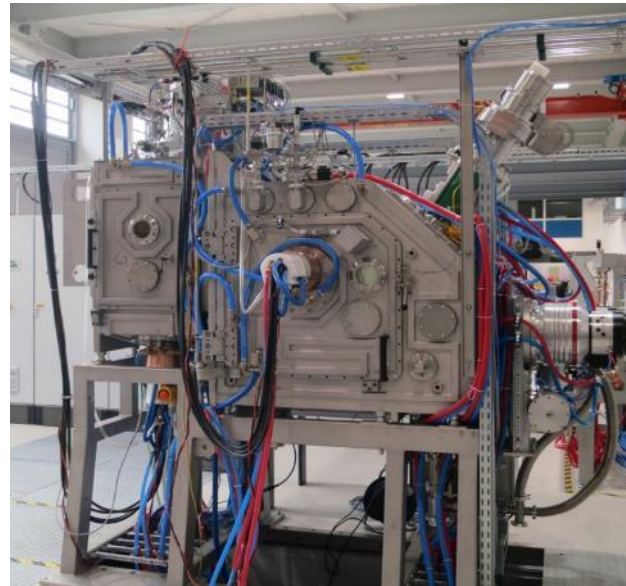


Platforms for Developing Coating Technologies

Lab-Scale Infrastructure



Process Development & Feasibility Studies



Upscaling & Pilot Production



Fraunhofer FEP process technologies

Large area, in-line configuration

Surface treatment

(plasma, ion, bias, electron beam, flash lamp annealing)

High-rate evaporation

(boat, inductive heating, electron beam, plasma assisted)

Magnetron sputtering

(DC, pulsed, hybrid, dual magnetron, reactive & non-reactive)

High-rate PECVD

(magPECVD, arcPECVD)

Non-vacuum processes

(slot die, electron beam)

Gas Phase Condensation

for nanoparticle generation

Process control

(in-line spectrometer, plasma emission, plasma impedance)

R&D

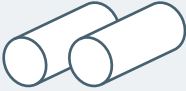
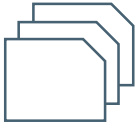



pilot

industrial



Substrate Form Factors at Fraunhofer FEP

Process development on different substrate geometries and surfaces

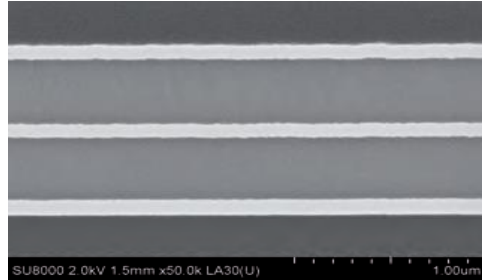
		Method	max. substrate size	Material			Thickness	
Roll-to-roll		Sputtering Electron beam evaporation	300 – 600 mm width	Metals	Polymers	Flexible glass	7 µm ... 200 µm	
Sheet-to-sheet		Inline sputtering (planar, tubular) magPECVD	600 x 1200 mm ² 650 x 750 mm ²				50 µm ... 6 mm 120 mm	
Sheets and strips		Electron beam evaporation	500 x 500 mm ² 300 mm width			Ceramics	Glass	15µm ...1.5 mm
3D objects		Sputter deposition PECVD	500 x 500 x 500 mm ³					-
Wafer		Sputter deposition (high rate)	Up to 300 mm diameter			Si	max. 20 mm	



Materials Characterization

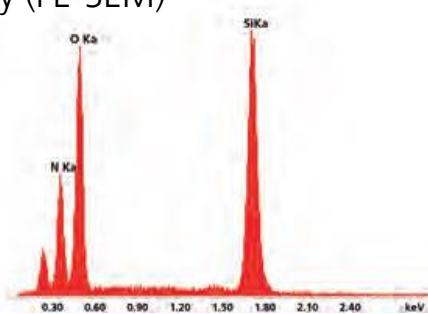
Microstructure

- Ultra-high resolution scanning electron microscopy (FE-SEM)
- Ion preparation of cross sections
- Metallography



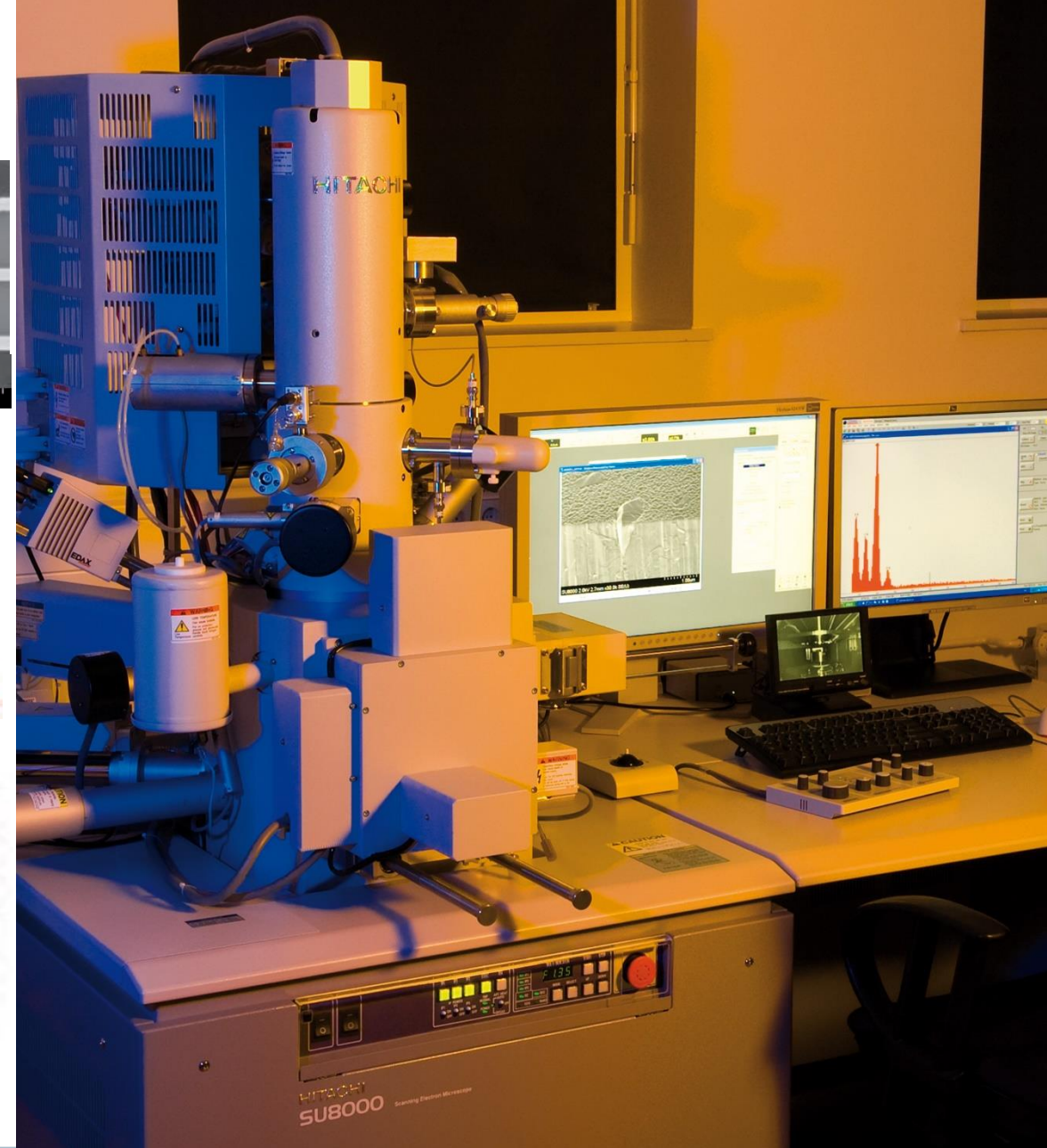
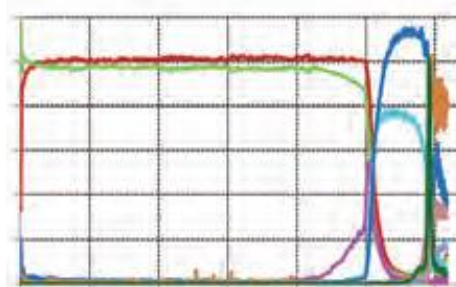
Chemical composition and topography

- Glow discharge optical emission spectrometry (GD-OES)
- Energy dispersive spectrometry (EDS)
- Atomic force microscopy (AFM)



Layer properties

- Permeation measurement (WVTR, OTR)
- Measurement of hardness (nanoindentation technique)
- Optical properties (spectroscopic ellipsometry)



Selected project and application examples

- **Coatings for emerging & sustainable technologies**
- **Technologies for life science applications**



USE CASE: Deformable protective coatings for PEM BPP by R2R

By high-rate plasma-activated EB evaporation



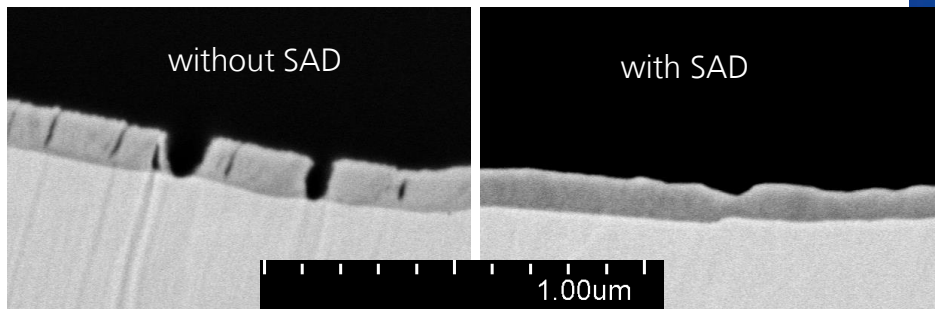
Demands

- Low contact resistance
- High resistance to corrosion in a wide oxidizing potential range
- Good formability without layer cracking
- Low cost processing

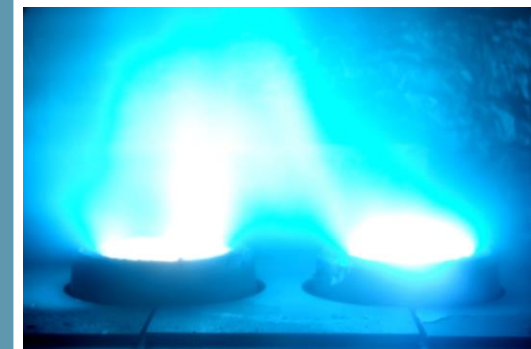
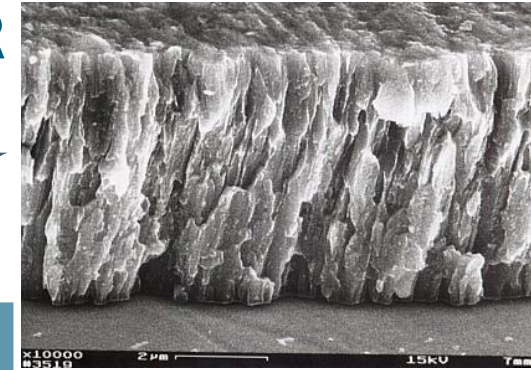
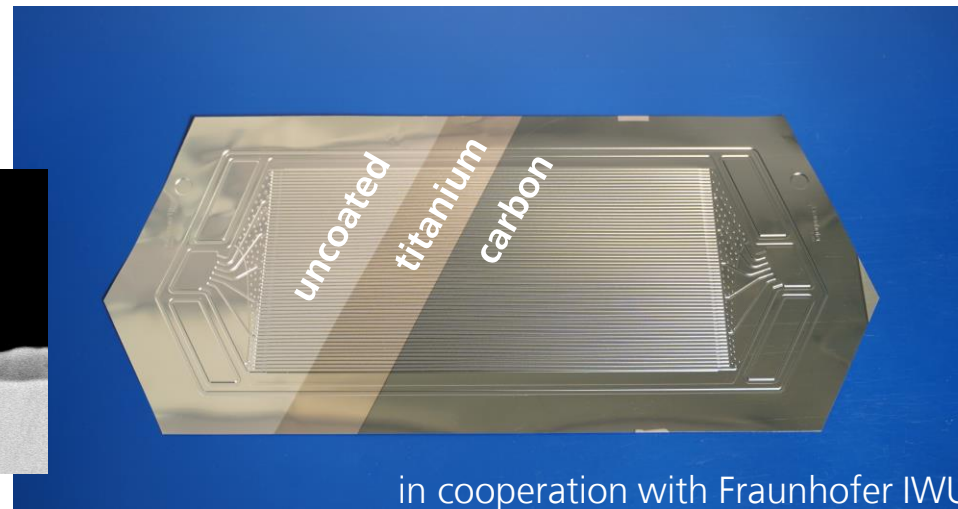
Technology

- High-power plasma processing + High-rate EB evaporation
- Roll-to-Roll vacuum processing with thin metal strips (pre-coating)

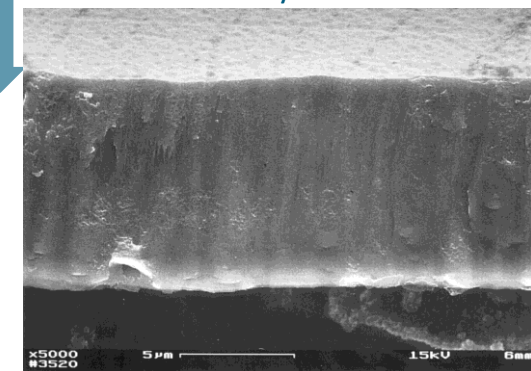
- EBPVD: high throughput technology
- Increased ductility and formability by plasma-activated evaporation (SAD)



cross-sections of Ti after 180° bending test

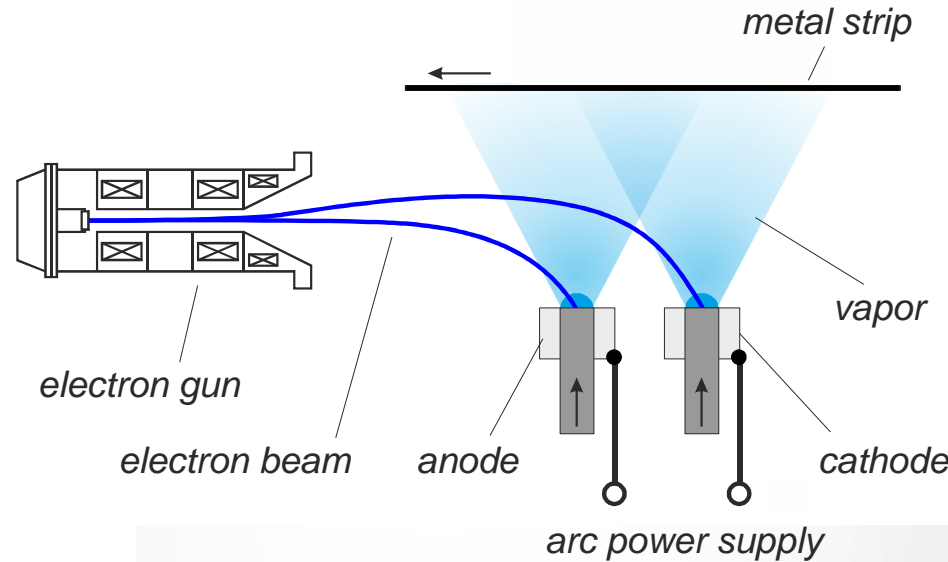


Plasma effect on the microstructure of thin titanium layers



EQUIPMENT: Device for Spotless arc Activated Deposition (SAD)

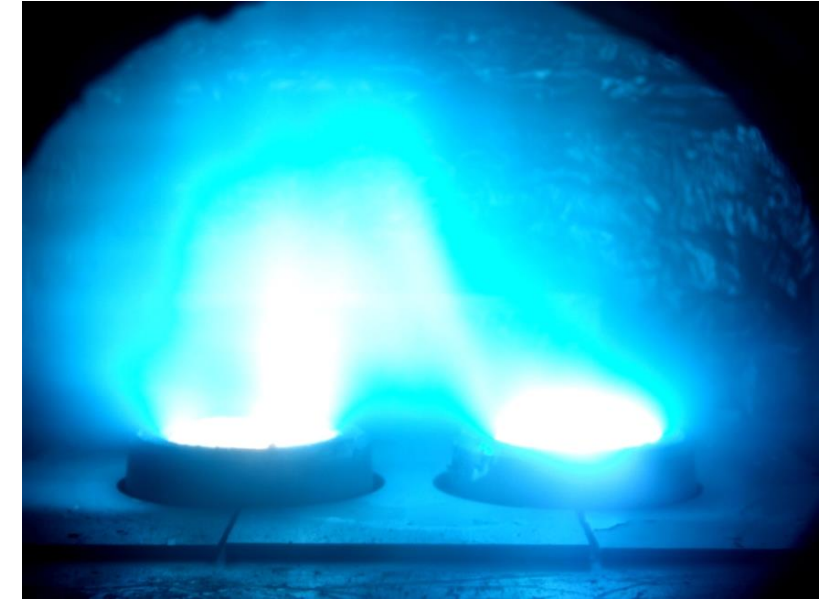
Using dual crucible



- Spotless arc discharge on two evaporating electrodes
- Cathode: high-melting metal, anode: same or other metal
- Plasma generation at cathode and anode
- Reactive processing possible
- Electrodes keep free by evaporation
- No layer deposition at any solid anode
- Optional DC / AC



Water-cooled dual crucible



spotless arc using dual crucible (2 x Ti)



EB evaporation of Ti from 2 crucibles by jumping beam



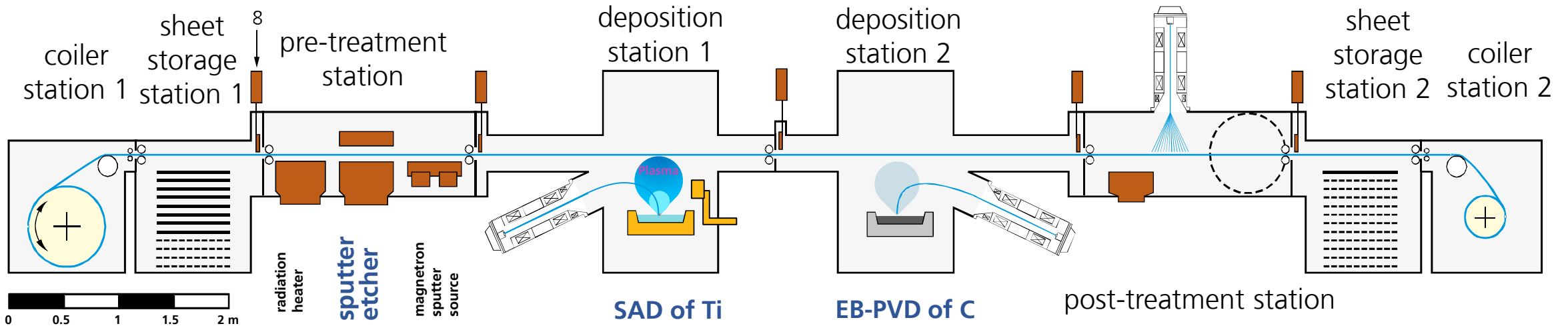
PLATFORM: In-line electron beam and sputter Coater MAXI

In-line vacuum coating equipment for metal strips and sheets



Features

- Single and double side coating of metal, plastic, glass or ceramic sheets with a maximum dimension of 500 mm × 500 mm
- Coating of metal strips with a maximum width of 300 mm and a maximum thickness of 1.5 mm
- Testing of key components under near-industrial conditions





USE CASE: Deposition of Carbon Nano Tubes (CNTs)

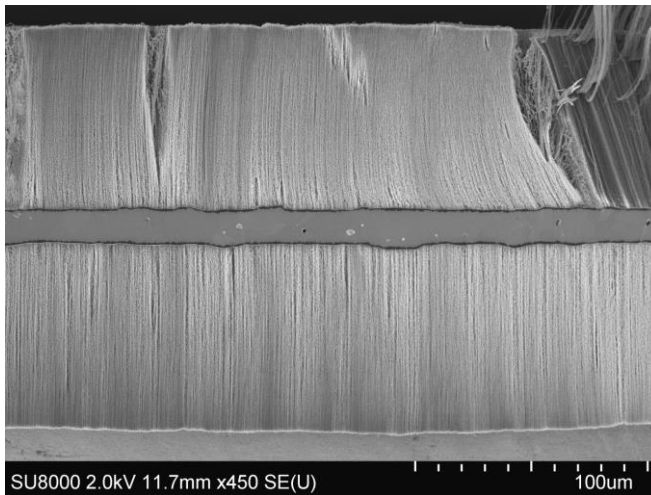
By chemical vapor deposition (CVD)

Process

- Double side coating of a metal strip with catalyst
- Heating by thermal radiation
- Addition of precursor gas → CVD of CNTs

Reached results

- Double side deposition of CNTs in an inline mode
- Various substrate materials usable



Top side CNTs ~80 μm

Metal foil 13 μm

Bottom side CNTs ~80 μm

Cross section of CNTs deposited (partially damaged by preparation)

It's the blackest material I have ever seen!



USE CASE: Deposition of Graphene Layers

By plasma-enhanced chemical vapor deposition in a roll-to-roll process



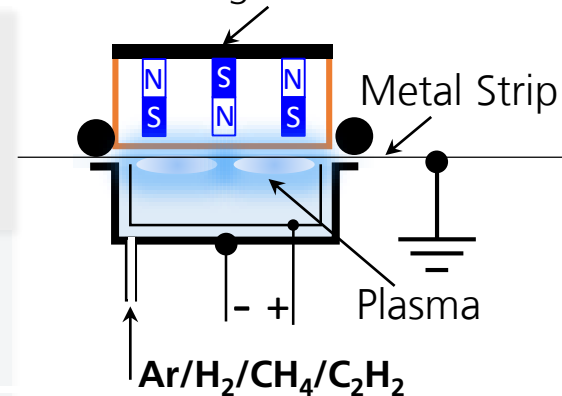
Process

- Double side coating of a steel strip with catalyst
- Rapid heating up to 1000°C by plasma device
- Addition of precursor gas → deposition of graphene by PE-CVD

Reached results

- Formation of graphene has been proven by Raman
- Lower temperatures (650 °C) & higher throughputs (17m²/h) feasible
- Quality of the layers has a high need for optimization

Inverse Magnetron Device



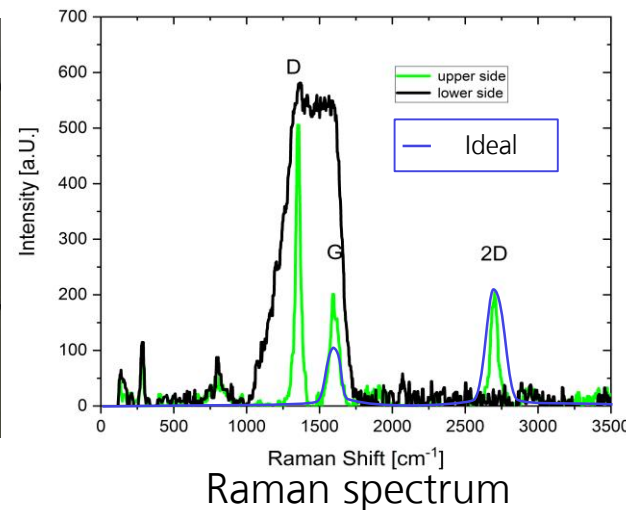
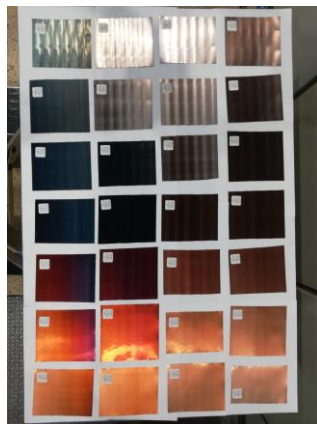
Upper side magnetron



Lower side magnetron
Stainless steel strip

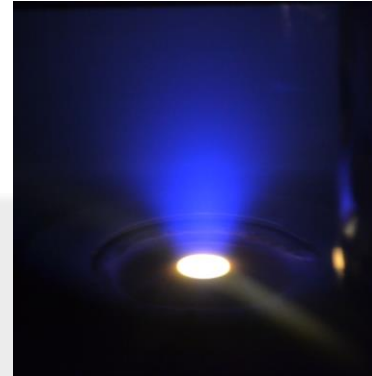


processed pieces of steel strip



USE CASE: Alternative protective coatings for PEM/electrolyser BPP

Performance-adjusted carbon coatings by anodic arc evaporation

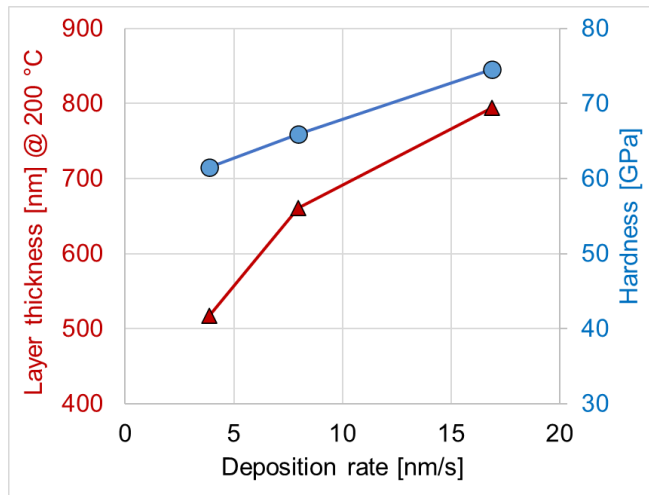


Challenge

- High cell voltage and high anode potential → corrosion sensitivity
- Demands for high corrosion resistance
- low contact resistance (target $\leq 0.01 \Omega \text{ cm}^2$)

Approach

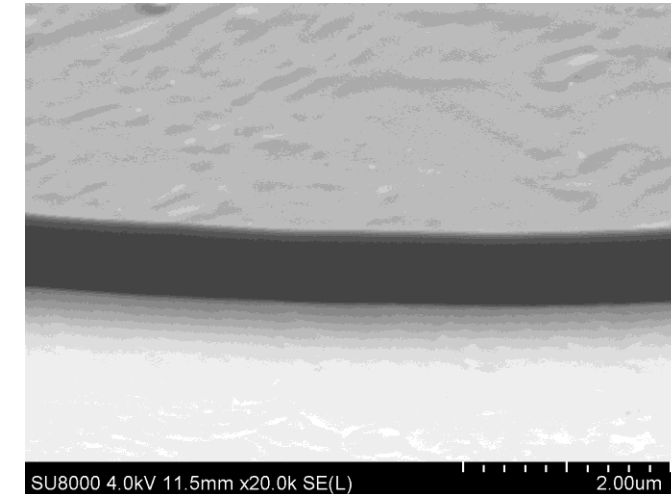
- Thin doped ta-C layers (extremely corrosion-resistant and electrically conducting)
- New plasma PVD method by anodic arc evaporation



Further use cases: Leveraging the high hardness for tribological applications

ta-C coatings (tetrahedral amorphous carbon)

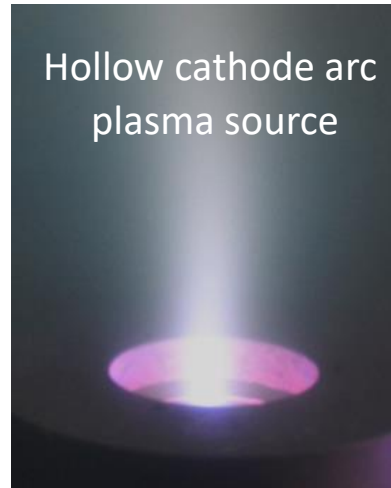
- Hydrogen-free carbon coatings
- Dominating sp^3 content
- Doping for enhanced electrical conductivity
- Hollow cathode arc source + Anodic arc evaporation
- Sublimation of graphite
- High ionization degree of vapor
- Motor driven material feed
- Relative high deposition rate ($\approx 17 \text{ nm/s} = 61 \mu\text{m/h}$)
- Low droplet emission mode



EQUIPMENT: Anodic Arc Evaporator

Features

- Plasma activated deposition
- High ionization degree (up to 100%)
- Relative low particle energies (compared to sputtering)
- High deposition rate
- Low droplet emission



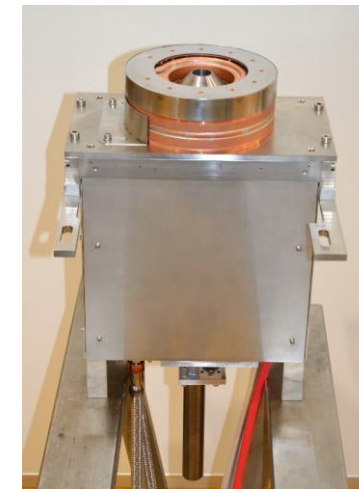
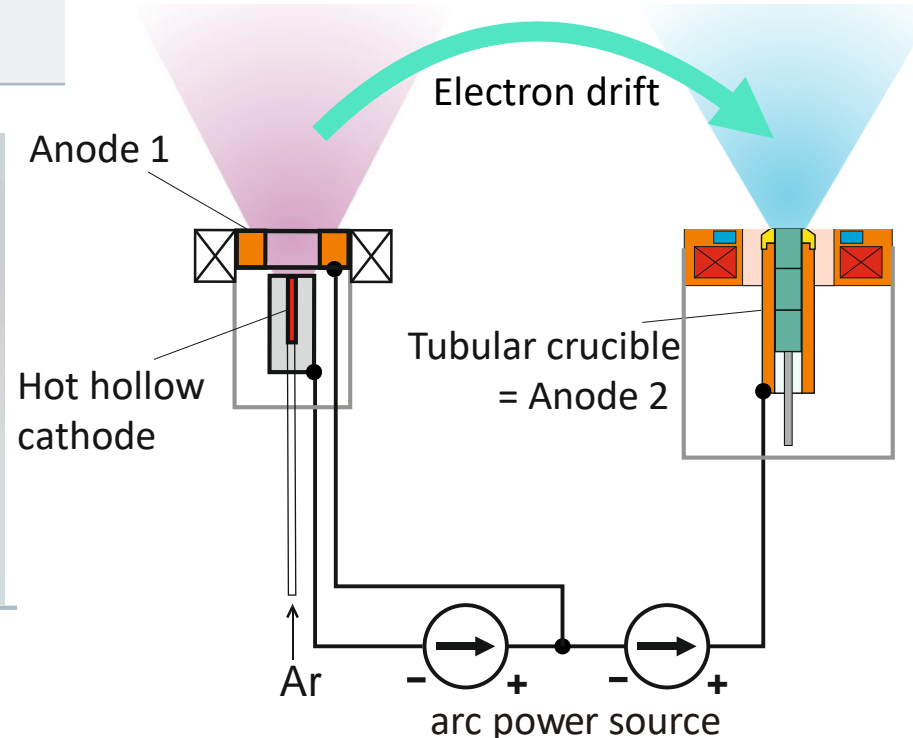
Evaporation of Indium-Tin-Oxide (ITO)

Transparent conductive oxides (TCO)

- Successfully with ITO, IZO, AZO
- Crystalline ITO layers at low temperature
- Excellent electrical and optical properties
- Extremely low roughness
Ra = 0,3 nm at ITO 300 nm thick
- Dep. rate 300 - 500 nm m/min

Hollow cathode arc plasma source LAVOPLAS

Large volume plasma source, 50 - 200 A



Anodic arc evaporator
0 - 200 A,
max. 20 kW
Motor-driven
evaporant feeding



USE CASE: Electron Beam and Plasma Technology for EB-PVD

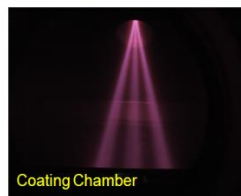
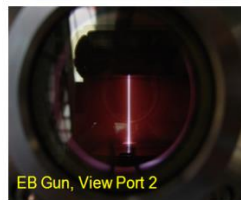
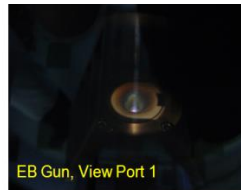
Equipment for advanced thermal barrier coating technologies for turbine components

Objectives

Application of enhanced thermal barrier coatings on turbine components for increased performance: higher operation temperature, engine efficiency, reliability and lifetime.
-> Enabling technology for expanded process parameter windows

Technology

- High-performance Electron Beam System ERIC-LVO
- Plasma-activated evaporation to adjust microstructure at exotic process conditions

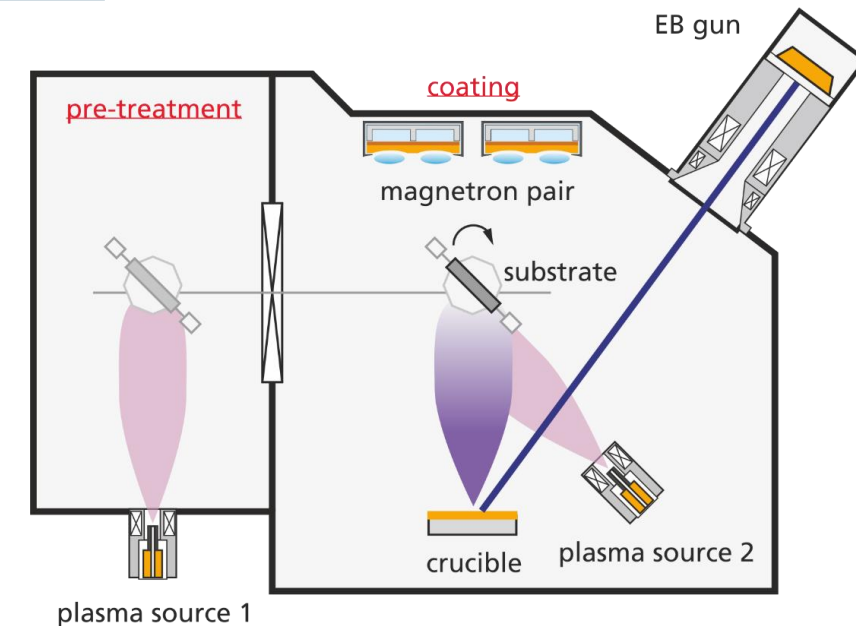
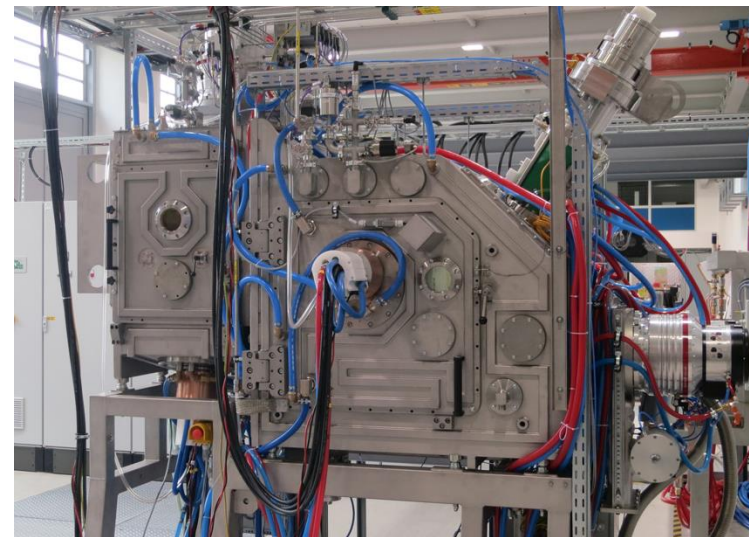
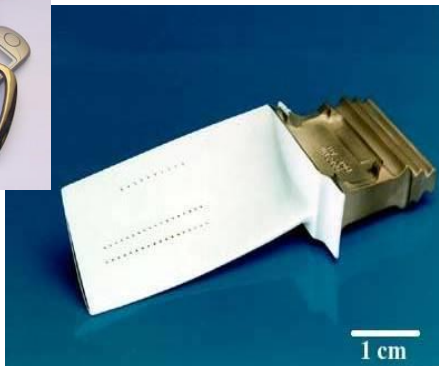
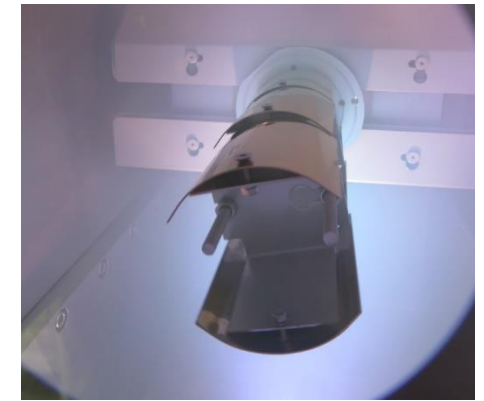


PLATFORM: Electron Beam Coating System NOVELLA

For processing of 3D parts



- Features**
- short-cycle plant with load-lock chamber
 - plasma-based electron gun (40 kV, 120 kW)
 - hollow cathode plasma sources (pre-treatment, plasma activation)
 - magnetron sputter sources (optional)
 - programmable substrate movement (translation + rotation)

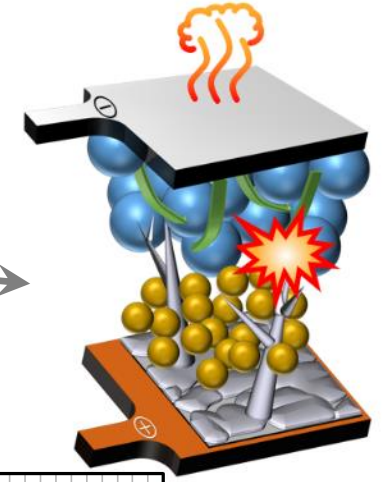
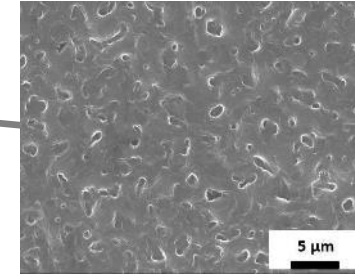


USE CASE: Silicon-based Next Generation Anodes for Lithium-Ion Batteries

low-cost, high-performance batteries for electromobility and the energy transition

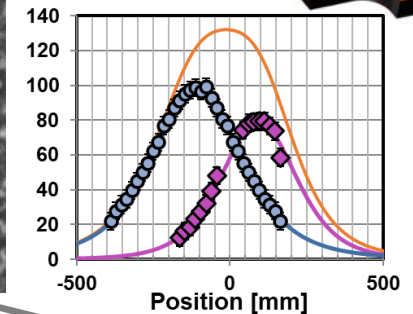
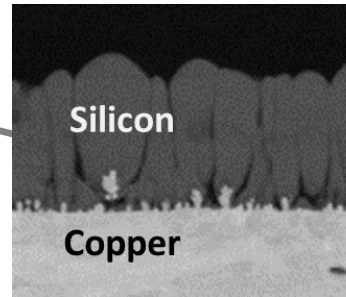
Lithium metal anodes & prelithiation

- by deposition of porous lithium layers
- by coating of electrodes



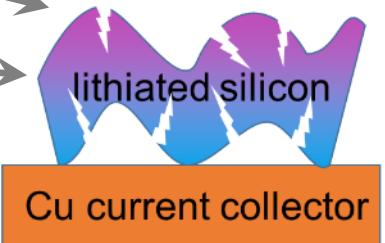
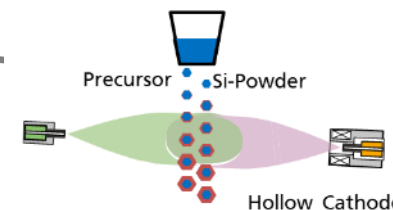
Porous silicon anodes

- by deposition of nodular silicon structures
- by vapor phase dealloying
- by deposition of pre-lithiated silicon layers



Silicon-carbon composite anodes

- by functionalization of silicon particles



Lightweight current collector

- by metallization of polymer films

[Piwko et al., J. Power Sources, 351 \(2017\) 183-191](#)
[Saager et al., Surf. Coat. Technol., 358 \(2019\) 586-593](#)
[Saager et al., Batteries, 9\(2\):75 \(2023\)](#)

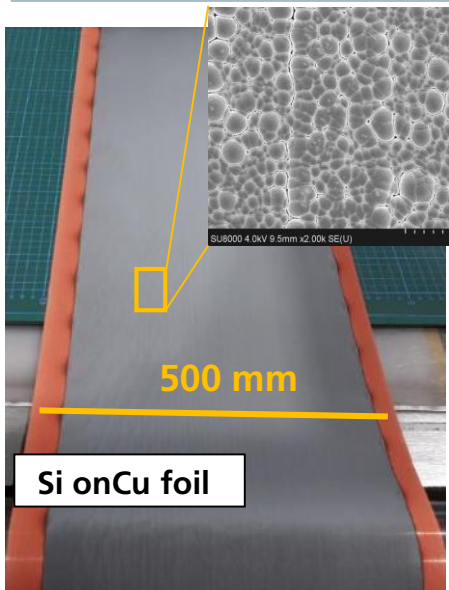
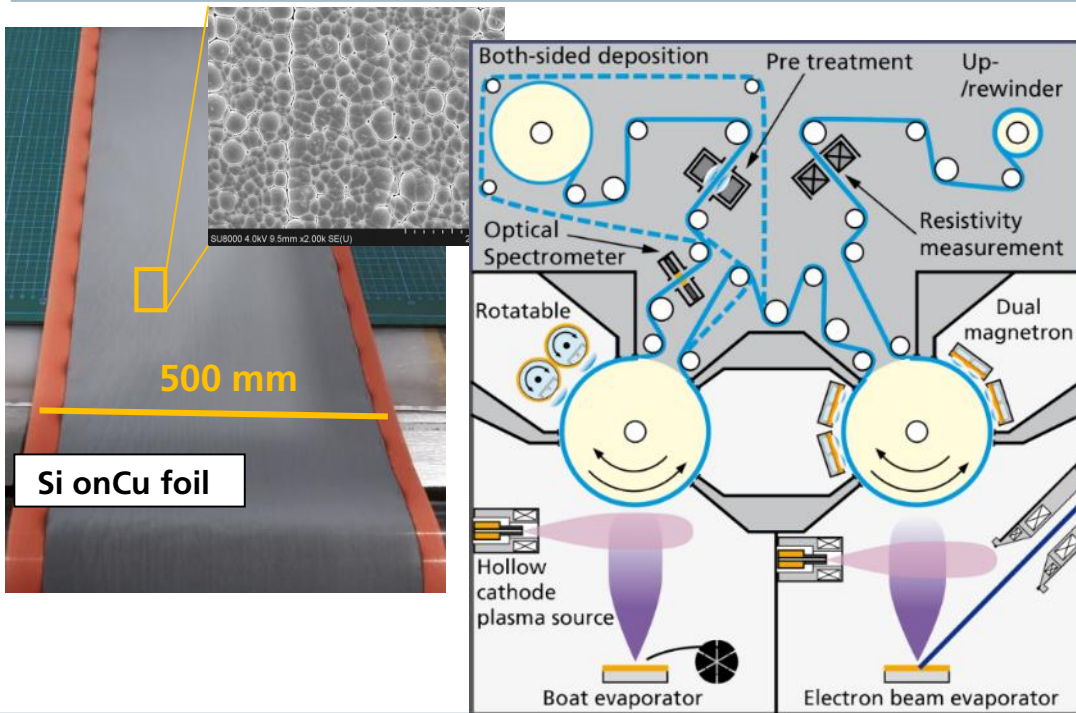
PLATFORM:



Pilot R2R Coater *novoFlex*[®] 600 Pilot

Features

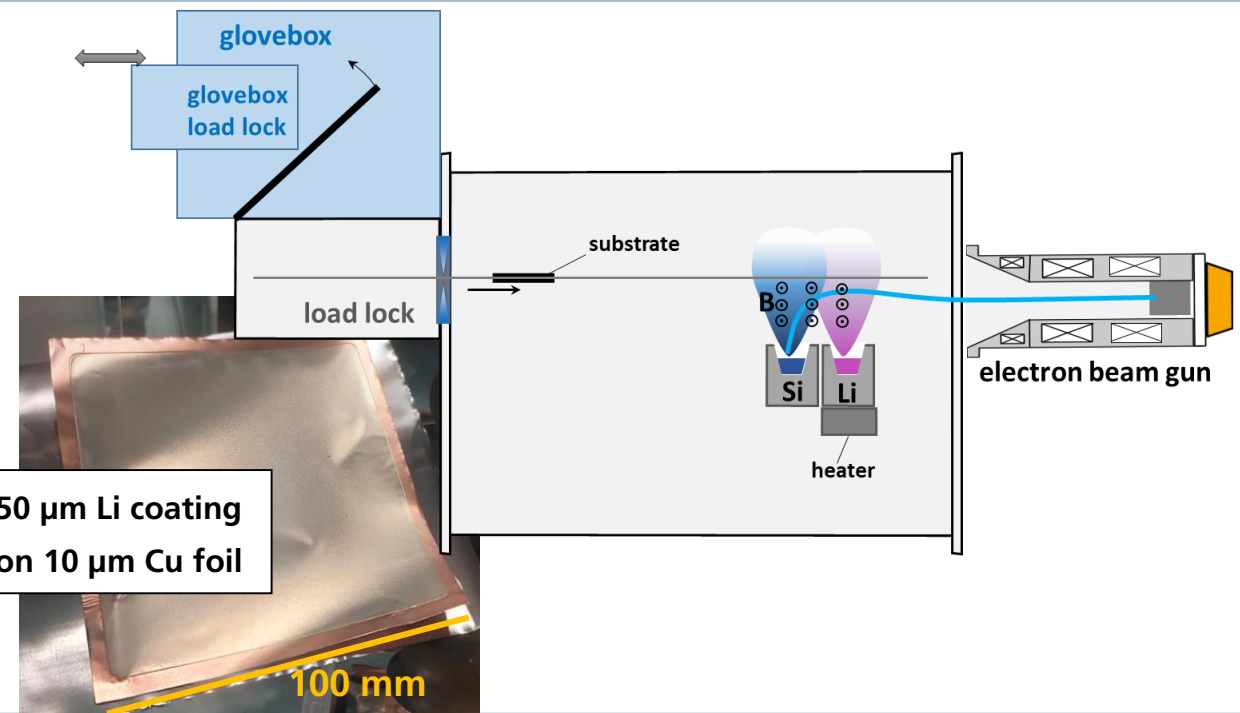
- Polymer films, metal foils up to 600 mm width
- Plasma assisted EBPVD, Sputtering, PECVD
- Inline pre-treatment, optical/electrical metrology



S2S Coater VERSA

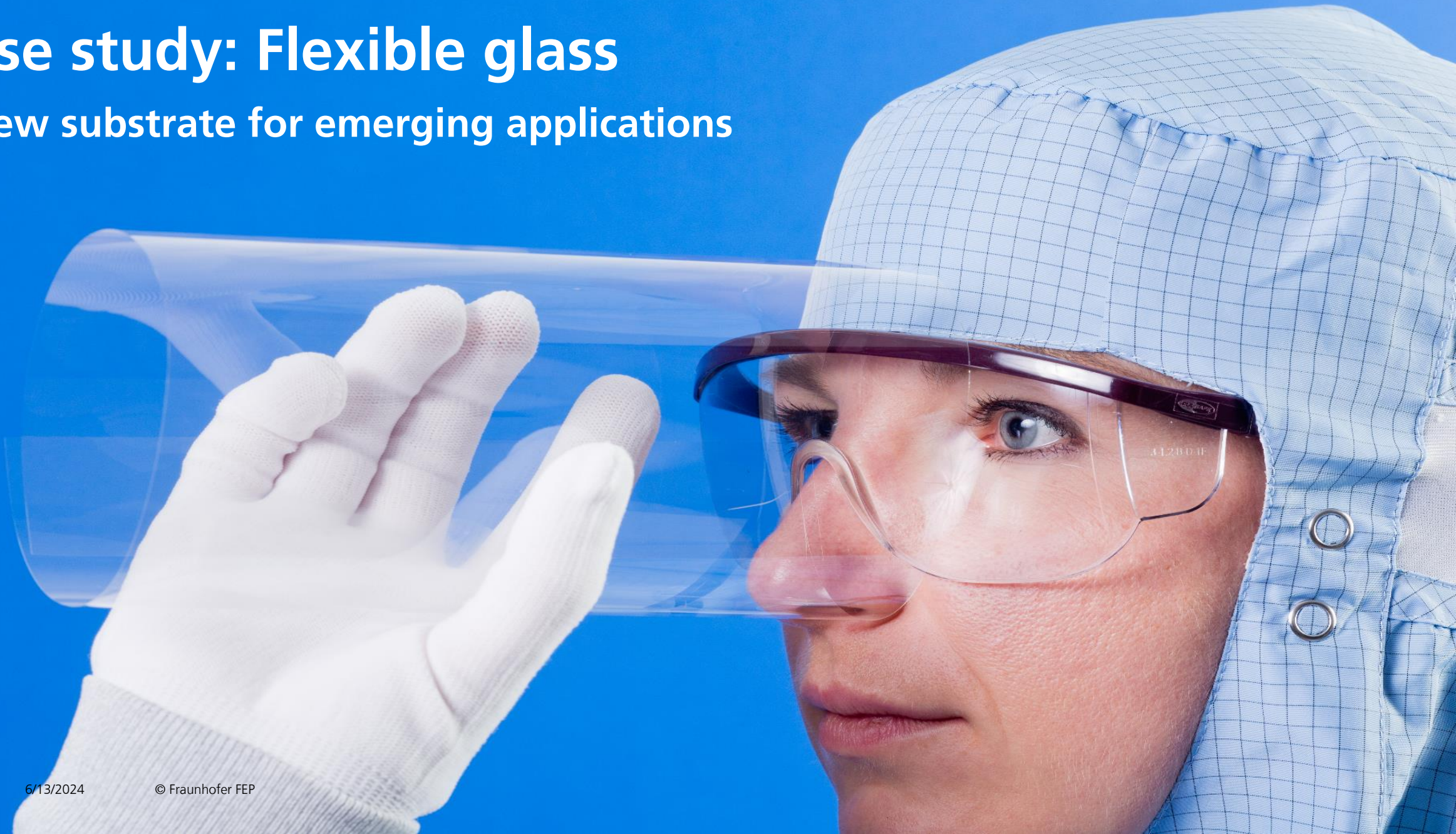
Features

- Sheets of metal, plastic, glass or ceramics up to 12×20 cm²
- Plasma assisted EBPVD, Sputtering, PECVD, thermal PVD
- Inert handling of air sensitive materials



Case study: Flexible glass

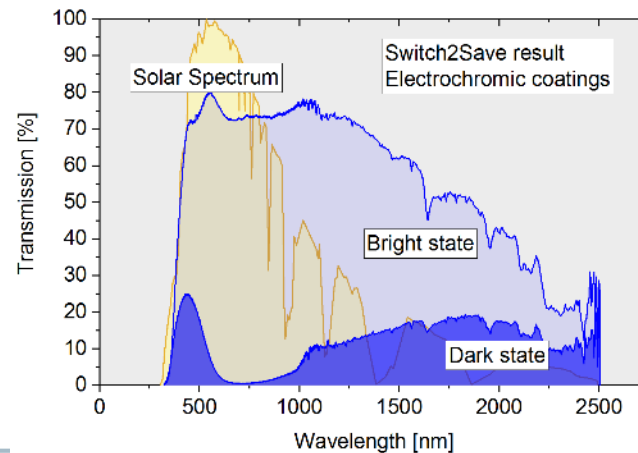
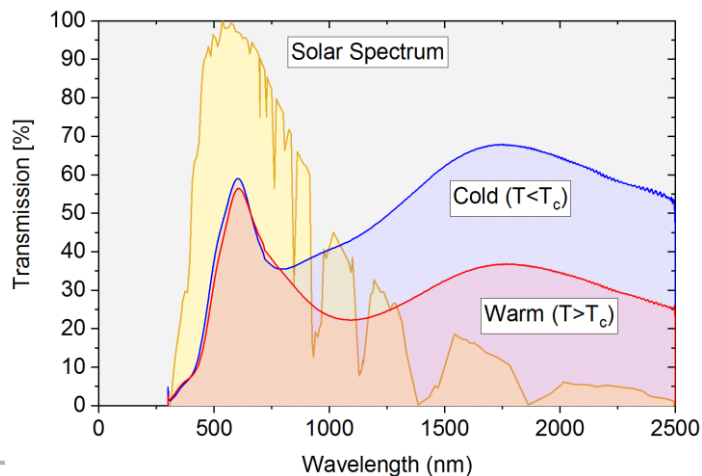
A new substrate for emerging applications



USE CASE: Thin film technologies for energy saving in architecture

Thermochromic coatings and electrochromic devices

- Objectives
 - Smart window technology for retrofitting existing buildings
 - R2R sputtering of thermochromic coatings on ultrathin flexible glass NEG G-Leaf, R2R sputtering of permeation barrier layers, transparent electrodes, optical layers
- Technology
 - Reactive HiPIMS at elevated substrate temperatures
 - Precise inline property monitoring
- Results
 - Roll-to-roll sputtering of thermochromic films on ultra-thin glass
 - Implementation of electrochromic windows in Vasakronan building in Sweden



PLATFORM: Laboratory Roll Coater FOSA labX

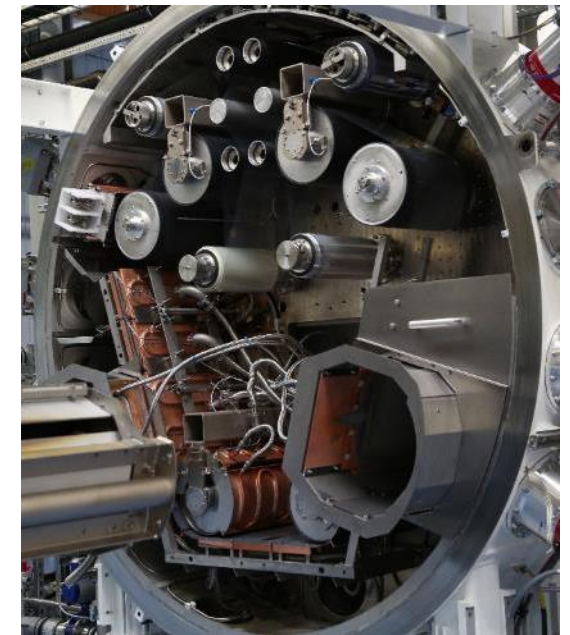
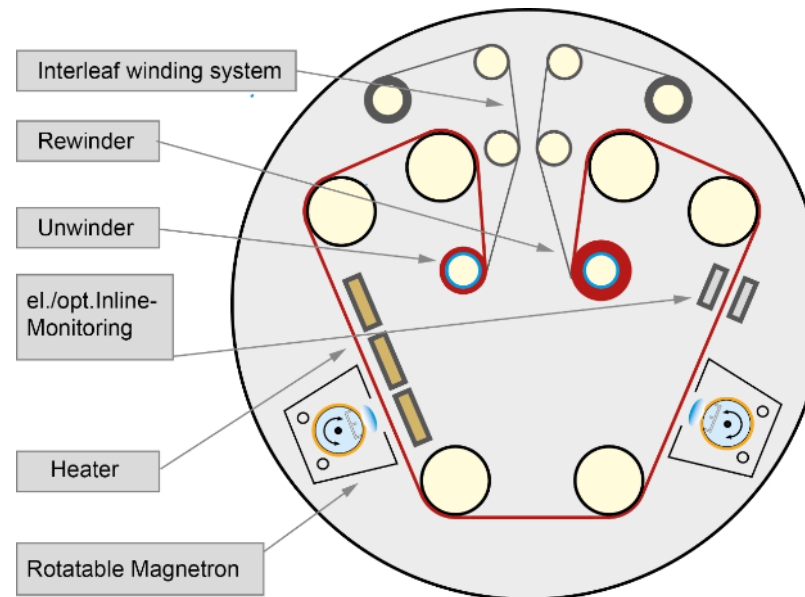


Objectives

- Sputtering & PECVD on flexible glass
- Large area upscaling of roll-to-roll processes, pilot deposition

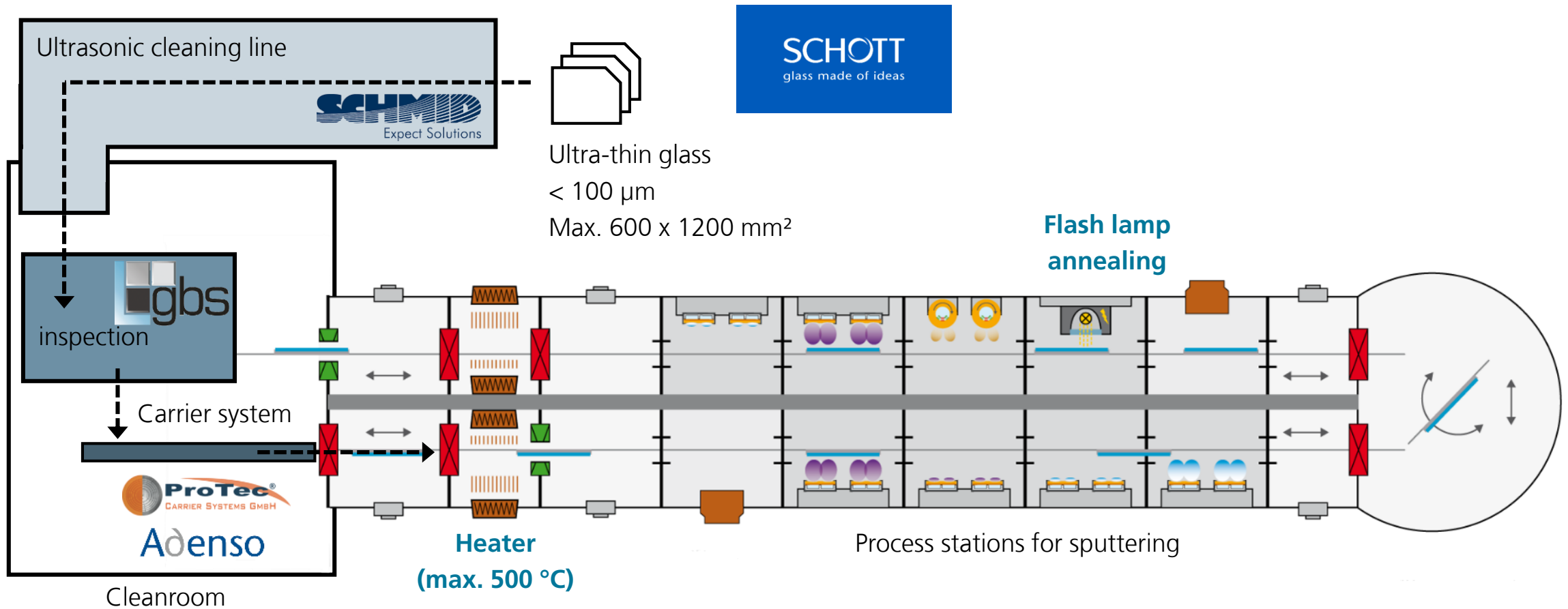
Features

- 300 mm deposition width, substrate temperature up to 300 °C
- Pulsed sputtering, HIPIMS, optical and electric inline monitoring



PLATFORM: S2S Process line for flexible glass

New process technologies pave the way for flexible glass applications



Selected project and application examples

- Coatings for emerging & sustainable technologies
- Technologies for life science applications



Phytosanitary Treatment of Seeds with Electrons

Control of pathogens to stop crop diseases and promote germination

Demands

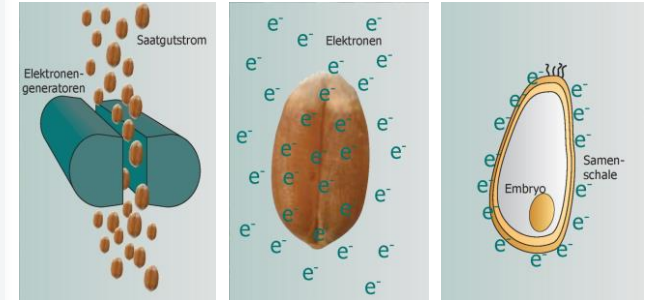
- Ecological (non-chemical) seed treatment on production scale

Technology

- Phytosanitary effect of electron seed treatment proven in long term studies together with German Federal Authorities
- > 20 years practical field experience by farmers in Germany
- No chemical agents, recommended for ecological farming
- Stops pollution of air, soil, water and protects users' health
- Mobile treatment plants with productivity up to 25 tons/hour
- New: Combination with biostimulants and nutrients dressings



[1]



Delivery of electrons by two linear sources

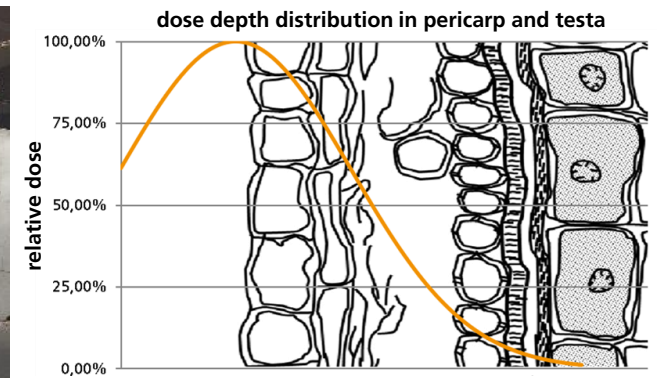
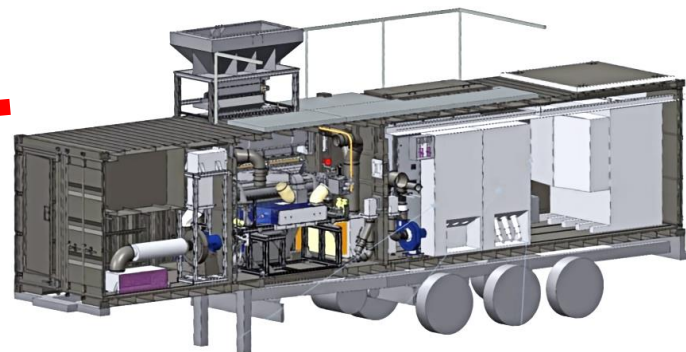
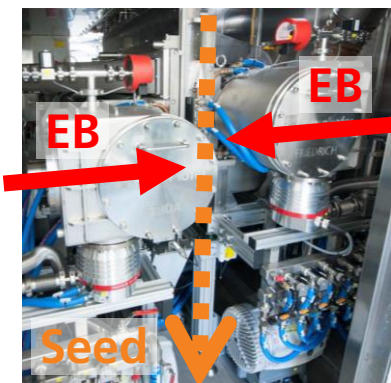
Singling of grains, free fall during treatment

All-round exposure by low-energy electrons

Physical disinfection of complete surface

Penetration of epispem: precise depth control

Embryo remains unaffected by electrons



[1] Useful effects of nutrients dressings (source: <https://seedforward.com/de/maisguard/>) .



Surface and Material Engineering

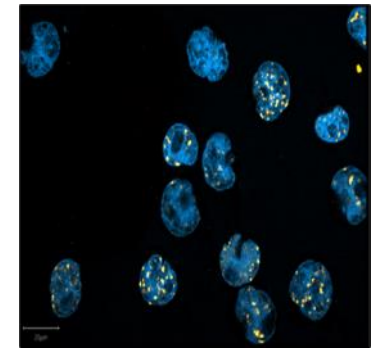
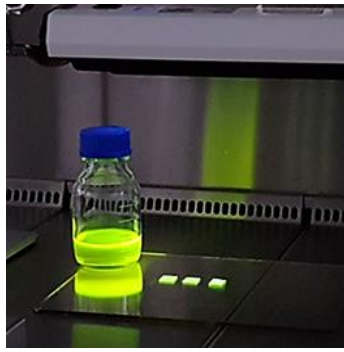
Assisted by non-thermal, low-energy electron beam technology

Demands

- sustainable biobased material engineering
- Glutaraldehyde-free preparation of biological tissue for medical devices like pericardial tissue applied to biological heart valve prostheses (improve functional life)
- Biogenic material development via cells and microorganisms
- Resource-saving, climate-neutral material innovations

Technologies

- Multi-step biological tissue preparation (patented SULEEI-Processing)
- Development of living building materials by scalable production of biogenic components via phototrophic microorganisms (substitution processes, assisted by EB technology)
- Development of biohybrid or synthetic cell-based tissues (assisted by EB-technology)



FEP Technologies for Hygienization

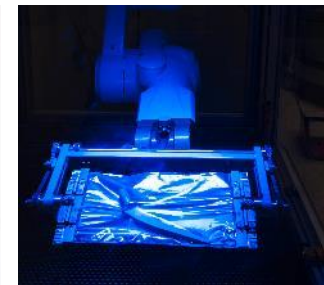
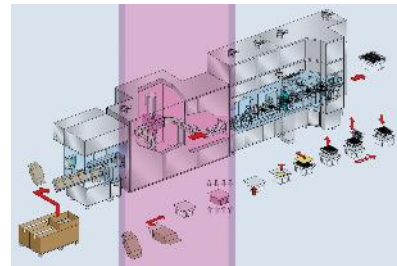
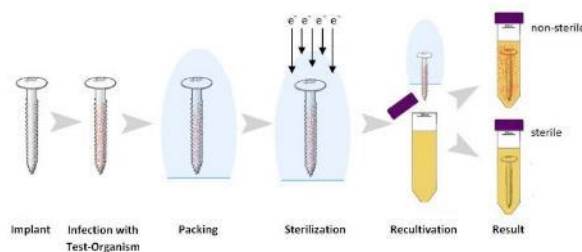
Applications from public sector up to medical technology

Demands

- Gentle sterilization of medical technical and pharmaceutical products
- In-line suitable technologies
- Sustainable alternatives to traditional disinfection and sterilization techniques
- Hygienization of surfaces in public environment, pharma industry as well as in the medical sector

Solutions

- Disinfection and sterilization by low-energy electron-beam technology
- Direct and indirect UV-based technologies (UV disinfection, UV induced photoactivity)
- Hygienic cleaning up to disinfection by means of plasma activated water (PAW)
- Microbiological evaluation and individualized test setups in FEP lab unit



Biomedical Laboratory Unit

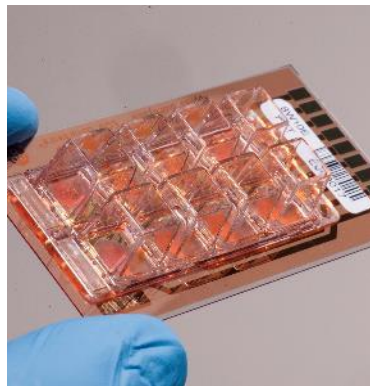
R&D Lab and service platform for customer specific requirements

Demands

- State of the art, smart lab unit for services and R&D in life sciences
- Equipment for microbiology, cell biology, biotechnology, chemistry, material and bio-analytics

Solutions

- Facility for the development of customer- and project-specific test regimes in accordance with DIN standards
- Expansion of the range of methods e.g. for testing the effectiveness of antimicrobial surfaces
- Extension **to biological protection level 2** for testing in a realistic environment



Summary



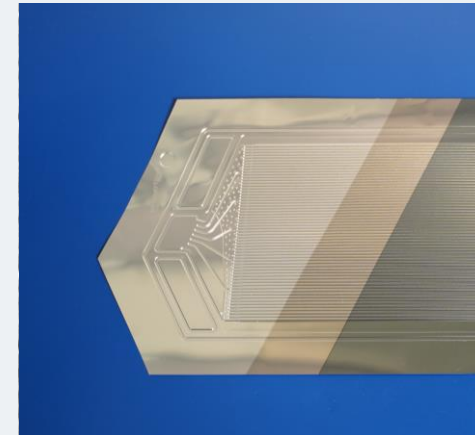
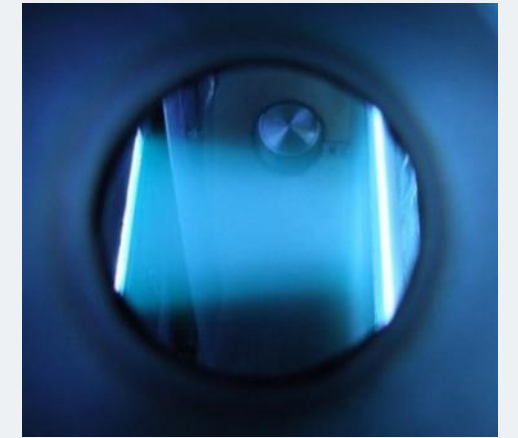
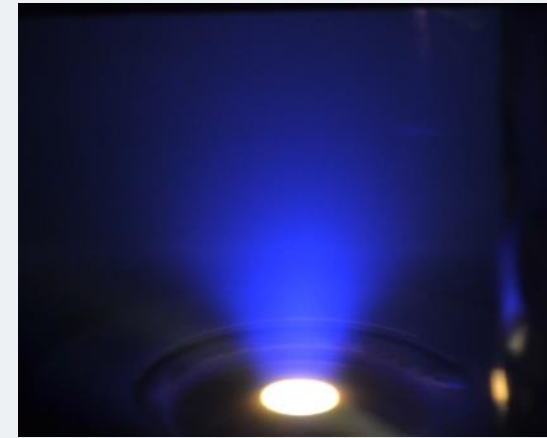
Our offer:

Competences and R&D Service

- Thin-film layer and process development mainly by plasma assisted PVD & EBPVD, magnetron sputtering, CVD and PECVD
- Refinement of thin-films by flash lamp annealing
- Flexible glass handling and processing
- Layer stack modeling, design and transfer
- Process setup, adjustment and optimization
- Coatings with high reproducibility
- Up-scaling, sampling, technology transfer
- Key component development

→ **Contract research, bilateral, exclusive**

→ **R&D, Feasibility studies, Sampling, prototyping**



We look forward to working with you from the concept phase right through to industrial implementation.



Fraunhofer Institute for Electron
Beam and Plasma Technology FEP

Contact

Dr. Stefan Saager
phone +49 351 2586-316
stefan.saager@fep.fraunhofer.de



Fraunhofer FEP
Winterbergstraße 28
01277 Dresden, Germany